

Specification of Thermoelectric Module

TEC2-31-17-04

Description

The TEC2-31-17-04 is a multistage module designed for greater temperature differential cooling, good for cooling and heating up to 100 °C applications. It is a 31-17 couples module in size of 15 mm × 15mm (top) / 20mm × 20mm (bottom). If higher operation or processing temperature is required, please specify, we can design and manufacture according to your special requirements.

Features

- High Temperature Differential
- No moving parts, no noise, and solid-state
- Compact structure, small in size, light in weight
- Environmental friendly
- RoHS compliant
- Precise temperature control
- Exceptionally reliable in quality, high performance

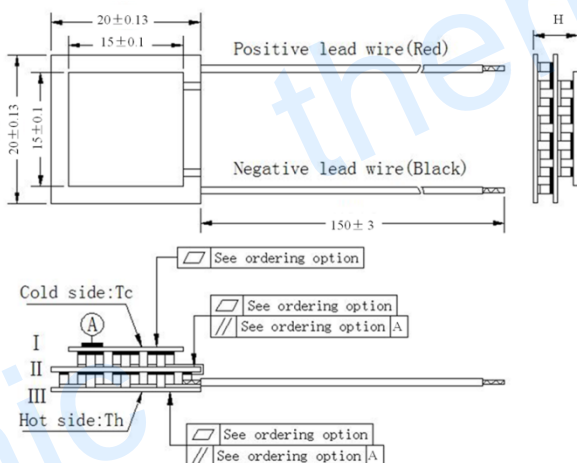
Application

- Infrared (IR) Sensors
- CCD Sensor
- Gas Analyzers
- Calibration Equipment
- CPU cooler and scientific instrument
- Photonic and medical systems
- Guidance Systems

Performance Specification Sheet

Th (°C)	7	50	Hot side temperature at environment: dry air, N ₂
DT _{max} (°C)	91	101	Temperature Difference between cold and hot side of the module when cooling capacity is zero at cold side
U _{max} (Voltage)	3.8	4.4	Voltage applied to the module at DT _{max}
I _{max} (Amps)	4.3	4.3	DC current through the modules at DT _{max}
Q _{Cmax} (Watts)	7.0	7.8	Cooling capacity at cold side of the module under DT=0 °C
AC resistance (Ohms)	0.73	0.80	The module resistance is tested under AC
Tolerance (%)	± 10		For thermal and electricity parameters

Geometric Characteristics Dimensions in millimeters



Manufacturing Options

A. Solder:

1. T100: BiSn (Melting Point=138°C)
2. T200: CuSn (Melting Point= 227 °C)

B. Sealant:

1. NS: No sealing (Standard)
2. SS: Silicone sealant
3. EPS: Epoxy sealant
4. Customer specify sealing

C. Ceramics:

1. Alumina (Al₂O₃, white 96%)(AIO)
2. Aluminum Nitride (AlN)

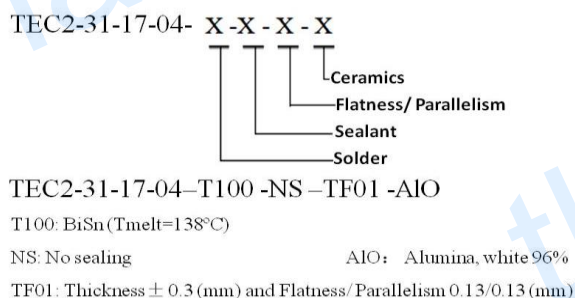
D. Ceramics Surface Options:

1. Blank ceramics (not metalized)
2. Metalized (Copper-Nickel plating)

Ordering Option

Suffix	Thickness H / (mm)	Flatness/ Parallelism (mm)	Lead wire length (mm) Standard/Optional length
TF	0:6.95±0.3	0:0.15/0.15	150±3/Specify
TF	1:6.95±0.2	1:0.13/0.13	150±3/Specify
TF	2:6.95±0.1	2:0.1/0.1	150±3/Specify
Eg. TF01: Thickness 6.9±0.3 (mm) and Flatness 0.1/0.15(mm)			

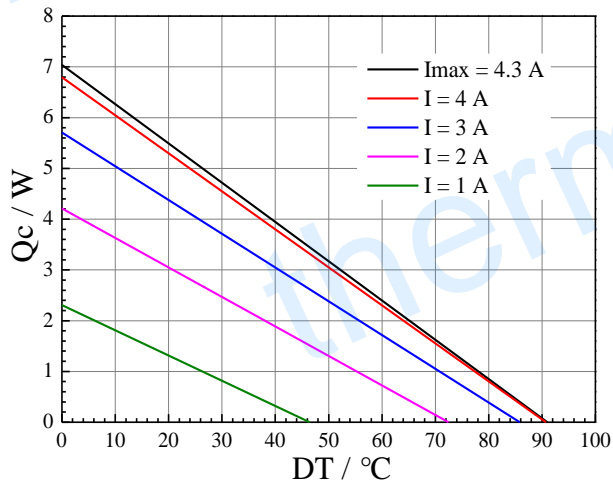
Naming for the Module



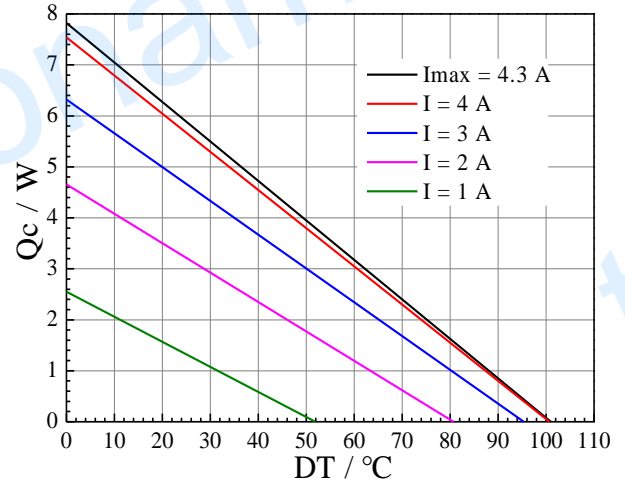
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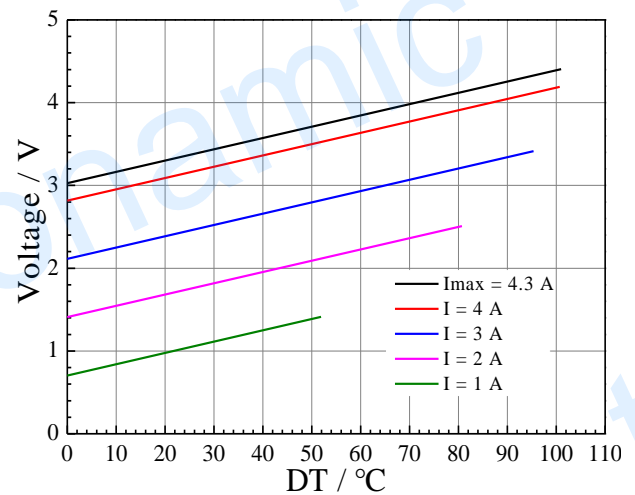
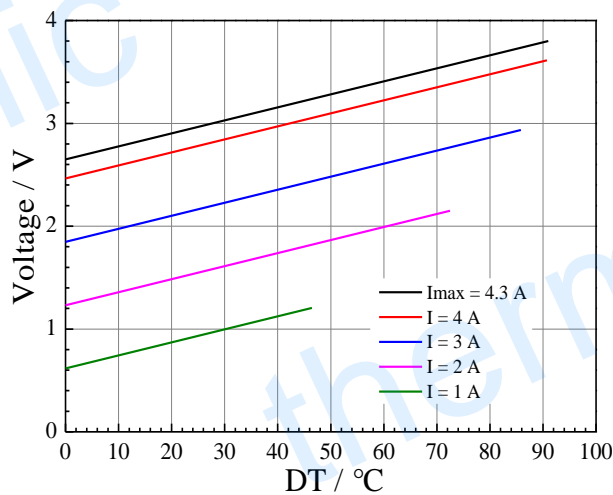
Performance Curves at $T_h=27\text{ }^\circ\text{C}$



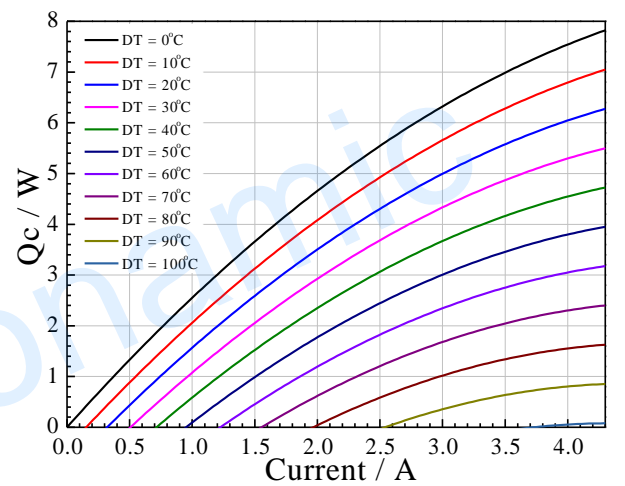
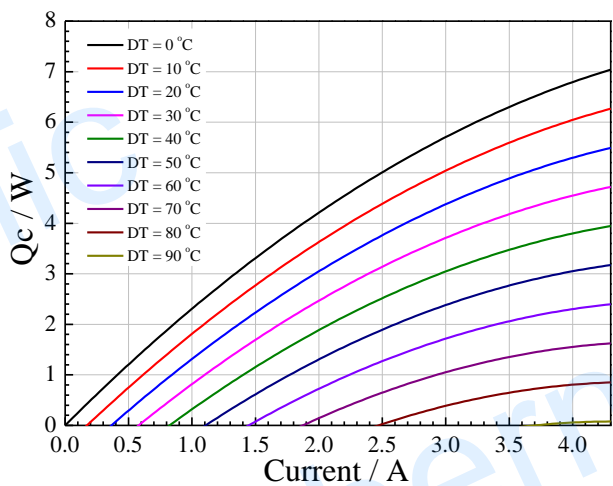
Performance Curves at $T_h=50\text{ }^\circ\text{C}$



Standard Performance Graph $Q_c = f(DT)$



Standard Performance Graph $V = f(DT)$



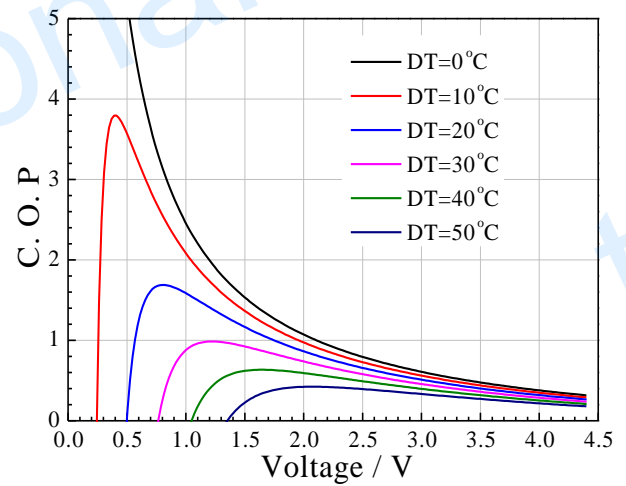
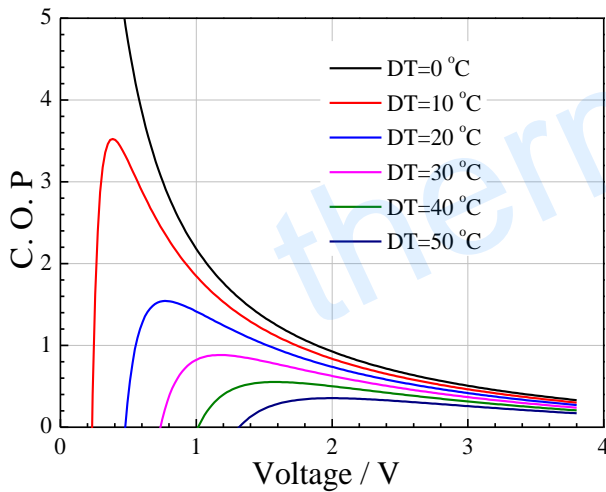
Standard Performance Graph $Q_c = f(V)$

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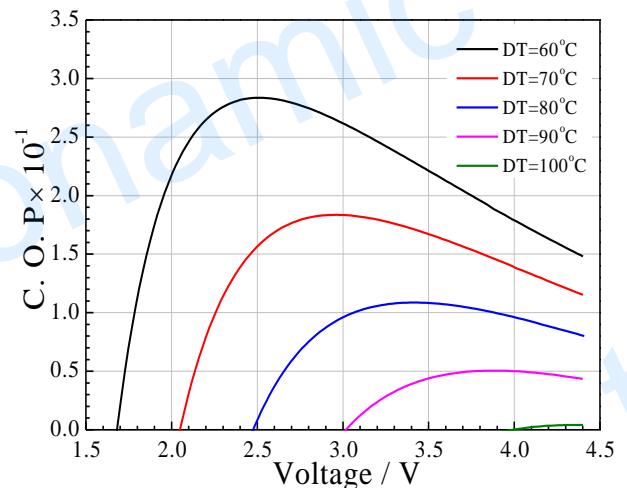
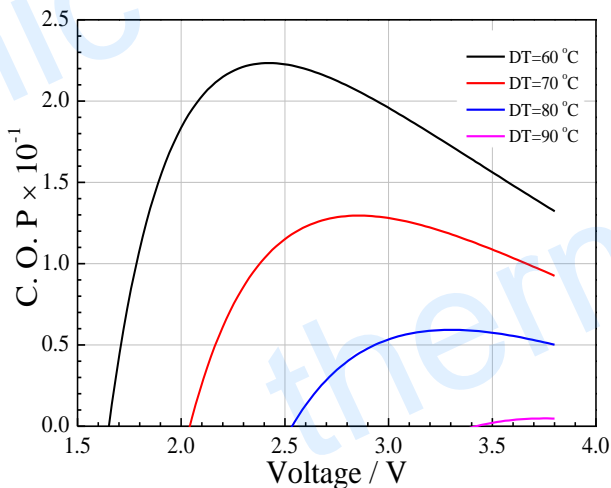
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Performance Curves at Th=27 °C

Performance Curves at Th=50 °C



Standard Performance Graph COP = f(V) of DT ranged from 0 to 50 °C



Standard Performance Graph COP = f(V) of DT ranged from 60 to 90/100 °C

Remark: The coefficient of performance (COP) is the cooling power Q_c /Input power ($V \times I$).

Operation Cautions

- Cold side of the module stucked on the object being cooled
- Hot side of the module mounted on a heat radiator
- Operation or storage module below 100 °C
- Operation below I_{max} or V_{max}
- Work under DC

Note: All specifications subject to change without notice.